

Application Data Sheet

Application Information

Application Type::	Regular
Subject Matter::	Utility
Suggested Group Art Unit::	N/A
CD-ROM or CD-R?::	None
Sequence submission?::	None
Computer Readable Form (CRF)?::	No
Title::	STRUCTURES AND METHODS FOR INTERGRATION OF ULTRALOW-K DIELECTRICS WITH IMPROVED RELIABILITY
Attorney Docket Number::	20140-00318-US
Request for Early Publication?::	No
Request for Non-Publication?::	No
Small Entity?::	No
Petition included?::	No
Secrecy Order in Parent Appl.?::	No

Applicant Information

Applicant Authority Type::	Inventor
Primary Citizenship Country::	US
Status::	Full Capacity
Given Name::	Stephen
Middle Name::	M.
Family Name::	Gates
Street of mailing address::	22 Inningwood Rd.
City of mailing address::	Ossining
State or Province of mailing address::	New York
Postal or Zip code of mailing address	10562
Country of mailing address::	USA

Applicant Authority Type:: Inventor
Primary Citizenship Country:: US
Status:: Full Capacity
Given Name:: Son
Family Name:: Nguyen
Street of mailing address:: 16 Parkway Drive
City of mailing address:: Yorktown Heights
State or Province of mailing address:: New York
Postal or Zip code of mailing address 10598
Country of mailing address:: USA

Correspondence Information

Correspondence Customer Number:: 30678

Representative Information

Representative Customer Number:: 30678

Assignee Information

Assignee name:: International Business Machines
Corporation
Street of mailing address:: New Orchard Road
City of mailing address:: Armonk
State or Province of mailing address:: NY
Postal or Zip Code of mailing address:: 10504